

L Number	Hits	Search Text	DB	Time stamp
3	2566028	air gap and conductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/28 09:08
4	123391	(air gap and conductor) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/28 09:08
5	26117	((air gap and conductor) and semiconductor) and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/28 09:09
6	6182	((((air gap and conductor) and semiconductor) and polymer) and decompos\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/28 09:09
7	1440	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/28 09:09	
8	451	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/28 09:10	